

# SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

N-Channel Silicon MOSFET

# ATP613 — General-Purpose Switching Device Applications

## **Features**

- Reverse recovery time t<sub>rr</sub>=60ns(typ.)
- Input Capacitance Ciss=350pF(typ.)
- · Halogen free compliance

- ON-resistance RDS(on)=1.55 $\Omega$ (typ.)
- · 10V drive

# **Specifications**

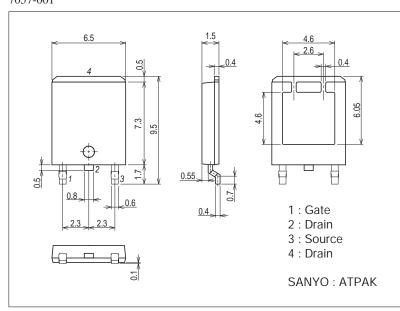
Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V <sub>DSS</sub>		500	V
Gate-to-Source Voltage	VGSS		±30	V
Drain Current (DC)	ID		5.5	Α
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	19	Α
Source-to-Drain Diode Forward Current (DC)	IS		5.5	Α
Source-to-Drain Diode Forward Current (Pulse)	ISP	PW≤10μs, duty cycle≤1%	19	Α
Allowable Power Dissipation	PD	Tc=25°C	70	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C
Avalanche Energy (Single Pulse) *1	EAS		93	mJ
Avalanche Current *2	IAV		5.5	А

Note :\*1  $V_{DD}$ =99V, L=5mH,  $I_{AV}$ =5.5A

#### **Package Dimensions**

unit : mm (typ) 7057-001



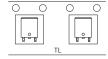
#### **Product & Package Information**

• Package : ATPAK

• JEITA, JEDEC :-

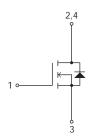
• Minimum Packing Quantity : 3,000 pcs./reel

#### Packing Type: TL Marking





# **Electrical Connection**



<sup>\*2</sup> L≤5mH, Single pulse (Fig.1)

### Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=10mA, VGS=0V	500			V
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =400V, V <sub>GS</sub> =0V			100	μΑ
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V			±100	nA
Cutoff Voltage	VGS(off)	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	3		5	V
Forward Transfer Admittance	yfs	VDS=10V, ID=2.75A	1.5	2.9		S
Static Drain-to-Source On-State Resistance	R <sub>DS</sub> (on)	I <sub>D</sub> =2.75A, V <sub>G</sub> S=10V		1.55	2.0	Ω
Input Capacitance	Ciss	V <sub>DS</sub> =30V, f=1MHz		350		pF
Output Capacitance	Coss			68		pF
Reverse Transfer Capacitance	Crss			15		pF
Turn-ON Delay Time	t <sub>d</sub> (on)	- See Fig.2		14.2		ns
Rise Time	t <sub>r</sub>			46		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)			37.6		ns
Fall Time	tf			20.4		ns
Total Gate Charge	Qg	V <sub>DS</sub> =200V, V <sub>GS</sub> =10V, I <sub>D</sub> =5.5A		13.8		nC
Gate-to-Source Charge	Qgs			3.2		nC
Gate-to-Drain "Miller" Charge	Qgd			7.6		nC
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =5.5A, V <sub>GS</sub> =0V		1.1	1.5	V
Reverse Recovery Time	t <sub>rr</sub>	See Fig.3		60		ns
Reverse Recovery Charge	Q <sub>rr</sub>	IS=5.5A, VGS=0V, di/dt=100A/μs		120		nC

Fig.1 Avalanche Resistance Test Circuit

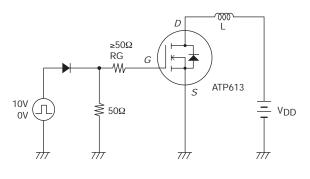


Fig.2 Switching Time Test Circuit

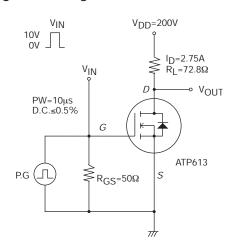
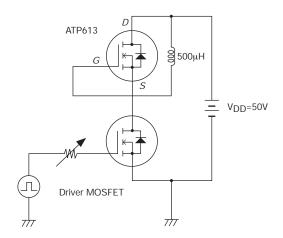
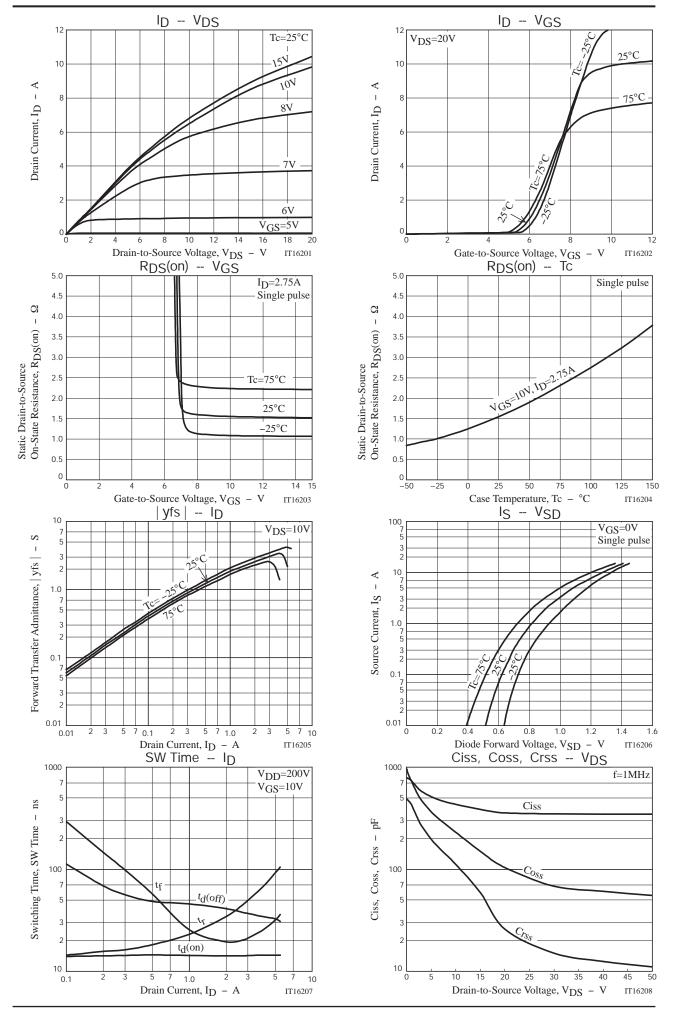
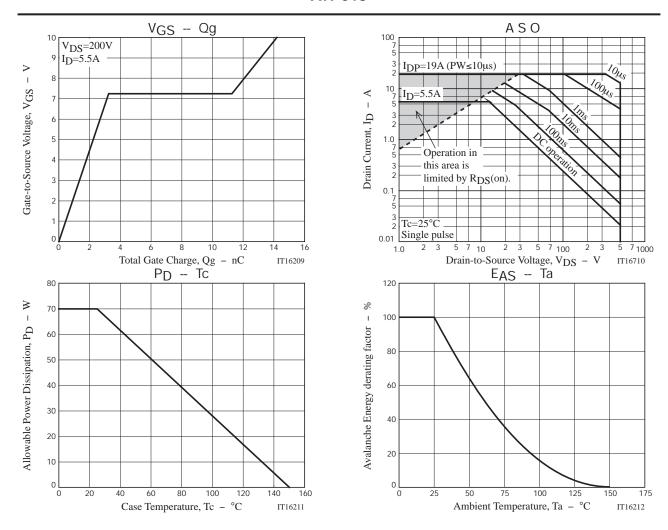


Fig.3 Reverse Recovery Time Resistance Test Circuit







Note on usage: Since the ATP613 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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